



*. C101 is a rework part.

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PCB Rev: A

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SVN Rev: Not in version control		Project Title: Buck converter with 50-275Vin (AC) and 9Vout/1.1W	
Drawn By: S Yu		Sheet Title: Buck converter with 50-275Vin (AC) and 9Vout/1.1W	
Engineer: S Yu		Assembly Variant: 001	Sheet: 1 of 1
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